

Docket No.: 060188-0685 PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Customer Number: 20277

Osamu MATSUI, et al.

Confirmation Number: 9750

Application No.: 10/690,705

Group Art Unit: 2811

Patent No. 6,975,003 B2

Filed: October 23, 2003

Examiner: Gene M. Munson

Issued: December 13, 2005

For: SEMICONDUCTOR DEVICE AND METHOD FOR FABRICATING THE SAME

REQUEST FOR CERTIFICATE OF CORRECTION UNDER 37 CFR 1.322

Mail Stop CERTIFICATE OF CORRECTION Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 Certificate

MAR 2 1 2006

of Correction

Sir:

In reviewing the above-identified patent, a printing error was discovered therein requiring correction in order to conform the Official Record in the application.

The error noted is set forth on the attached copy of form PTO-1050 Rev. 2-93 in the manner required by the Commissioner's Notice.

Specifically, on the title page and at the top of Column 1 in the specification, Item "(54)", change the title from SEMICONDUCTOR CMOS SOI" to -- SEMICONDUCTOR DEVICE AND METHOD FOR FABRICATING THE SAME --. Copies of the Declaration and Issue Fee transmittal form, showing the correct version of the title are enclosed.

In addition, on the title page, Item "(56) **References Cited**", below the listing of "6,313,508 B1 11/2001 Kobayashi", insert the following: -- FOREIGN PATENT DOCUMENTS 3111947

10/690,705

6,975,003

9/2000 (JP) --. This patent is mentioned on Page 1, line 11, of the specification, a copy of which

is attached.

The change requested herein occurred as a result of printing the Letters Patent and the

Certificate should be issued without expense under Rule 322 of the Rules of Practice.

Accordingly, Applicants request issuance of the Certificate of Correction.

Please charge any shortage in fees due in connection with the filing of this paper to Deposit

Account 500417 and please credit any excess fees to such deposit account.

Respectfully submitted,

McDERMOTE/WILL & EMERY LLP

Michael E. Fogart

Registration No. \$6,139

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Phone: 202.756.8000 MEF:bd Facsimile: 202.756.8087

Date: March 17, 2006

Please recognize our Customer No. 20277 as our correspondence address.

UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

PATENT NO. : 6975003 B2

DATED: December 13, 2005

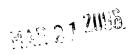
INVENTOR(S): Osamu MATSUI, et al.

It is certified that error appears in the above-identified patent and that said Letter Patent is hereby corrected as shown below:

TITLE PAGE,

Item "(54)" and top of Column 1, change "SEMICONDUCTOR CMOS S0I" to -- SEMICONDUCTOR DEVICE AND METHOD FOR FABRICATING THE SAME --.;

Item "(56) References Cited", following the listing "6,313,508 B1 11/2001 Kobayashi", insert -- FOREIGN PATENT DOCUMENTS 3111947 9/2000 (JP) --



PART B - FEE(S) TRANSMITTAL						
Complete and send (this form, together w	ipplicated 7 2006 w	fee(s), to: M or F	Commissione P.O. Box 1450 Alexandria, V	r Patents 0 Virginia 22313-1450	
INSTRUCTIONS: This fo	orm should be used for	remitting 188	UE FEE and I	PUBLICATION FEE (if I	required). Blocks I through 5 es will be mailed to the currer ress; and/or (b) indicating a sep	should be completed wh
indicated unless corrected maintenance fee notification	below or directed otherwis	e in Block I, by (a) specifying a	new correspondence addi	ress; and/or (b) indicating a sep	parate "FEE ADDRESS"
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Jack Q. Lever, Jr McDERMOTT, W 600 Thirteenth Stre Washington, DC 2	ILL & EMERY LLI eet, N.W.)			Certificate of Mailing or Tran at this Fee(s) Transmittal is being the with sufficient postage for final Mail Stop ISSUE FEE addres USPTO (703) 746-4000, on the	nemiesion
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APPLICATION NO.	FILING DATE	 	FIRSTALAND	1)11/(7) (70)		(D
10/690,705	10/23/2003		FIRST NAMED Osamu N		ATTORNEY DOCKET NO.	CONFIRMATION NO.
TITLE OF INVENTION: SI		E AND METHOD			60188-685	9750
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EXAM	INER	ART UN	IT I	CLASS-SUBCLAS S		
MUNSON,	GENE M	2811		257-351000		
1. Change of correspondence address or indication of "Fee Address" (37 CFR 1.363). Change of correspondence address (or Change of Correspondence Address form PTO/SB/122) attached. "Fee Address" indication (or "Fee Address" Indication form PTO/SB/47; Rev 03-02 or more recent) attached. Use of a Customer Number is required.			2. For printing on the patent front page, list (1) the names of up to 3 registered patent attorneys or agents OR, alternatively, (2) the name of a single firm (having as a member a registered attorney or agent) and the names of up to 2 registered patent attorneys or agents. If no name is listed, no name will be printed.			
3. ASSIGNEE NAME AND	RESIDENCE DATA TO B	E PRINTED ON T	HE PATENT (print or type)		
PLEASE NOTE: Unless recordation as set forth in	an assignee is identified be 37 CFR 3.11. Completion of	low, no assignee of this form is NO	data will appea Γa substitute fo	r on the patent. If an assi r filing an assignment.	ignee is identified below, the d	ocument has been filed
PLEASE NOTE: Unless an assignee is identified below, no assignee data will appear on the patent. If an assignee is identified below, the document has been filed recordation as set forth in 37 CFR 3.11. Completion of this form is NOT a substitute for filing an assignment. (A) NAME OF ASSIGNEE (B) RESIDENCE: (CITY and STATE OR COUNTRY)						
MATSUSHITA ELEC	CTRIC INDUSTRIA	L CO., LTD	•	OSAKA, JA	APAN	
Please check the appropriate	assignee category or categor	ies (will not be pri	nted on the pate	ent): 🗖 Individual 💆	Cornoration or other private ore	oun entity \(\int \) Governm
4a. The following fee(s) are enclosed: 4b. Payment of Fee(s):						
issue Fee A check in the amount of the fee(s) is enclosed.						
Publication Fee (No small entity discount permitted) Advance Order - # of Copies Four Payment by credit card. Form PTO-2038 is attached. The Director is hereby authorized by charge the required fee(s), or credit any overpayment					4°4	
Deposit Account Number 3004.17 (enclose an extra copy of this form).						
5. Change in Entity Status (a. Applicant claims SM	from status indicated above) IALL ENTITY status. See 3		b. Applican	t is no longer claiming SM	ALL ENTITY status. See 37 CF	FR 1.27(g)(2)
The Director of the USPTO is NOTE: The Issue Fee and Pul interest as shown by the recor	requested to apply the Issu- blication Fee (if required) w ds of the United States Pater	e Fee and Publicati ill not be accepted nt and Trademark (on Fee (if any) from anyone of Office.	or to re-apply any previou ther than the applicant; a re	asly paid issue fee to the applicategistered attorney or agent; or th	tion identified above. e assignee or other part
Authorized Signature			-	· · · · · · · · · · · · · · · · · · ·	04/18/2005	
Typed or printed name Michael E. Fogarty Registration No. 36,139						
This collection of information is required by 32 CFR 1.311. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to proc an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 12 minutes to complete, including gathering, preparing, submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to comp this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P Box 1450, Alexandria, Virginia 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 14 Alexandria, Virginia 22313-1450. Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number.						

Docket No.	



ARATION/POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

iviy resider	ice, post o	ince address ar	nd citizenship are as stated be	elow next to my name.
original, first and jo	oint invent hich a pate CTOR DE	or (if plural nant is sought on VICE AND M	sole inventor (if only one names are listed below) of the the invention entitled ETHOD FOR FABRICATING	subject matter which is
7		·	·	
(check one)	X	is attached he	ereto.	
		was filed on _ Application S	erial No.	as
I hereby sta	ate that I h	nave reviewed a aims, as amend	and understand the contents led by any amendment referre	of the above identified ed to above.
I acknowled application in accor	ige the dut	y to disclose inf h Title 37, Cod	formation which is material to le of Federal Regulations, §	the examination of this 1.56(a).
I hereby cla	im foreign (s) for pat application	priority beneficent or inventor for patent or in	ts under Title 35, United Star r's certificate listed below ar nventor's certificate having a	tes Code, § 119 of any
Prior Foreign Appli	cation(s)			Priority Claimed
2002-309319		JAPAN	24/10/2002	<u>X</u> Yes No
(Number)		(Country)	(Day/Month/Year Filed	$\frac{X}{X} = \frac{1}{1}$
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(Number)		(Country)	(Day/Month/Year Filed	Yes No
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I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Appln. Serial No.)	(Filing Date)	(Status-patented, pending, abandoned)
(Appln. Serial No.)	(Filing Date)	(Status-patented, pending, abandoned)
the patent application ic Trademark Office connec (Reg. No. 28,149); Kenn- Paul Devinsky (Reg. No.	dentified above and to ted therewith: Raphae eth L. Cage (Reg. No. 2 b. 28,553); Edward E. b); Brian E. Ferguson (I	wer of substitution and revocation, to prosecute transact all business in the U.S. Patent and IV. Lupo (Reg. No. 28,363); Jack Q. Lever, Jr. 26,151); Stanislaus Aksman (Reg. No. 28,562); Kubasiewicz (Reg. No. 30,020), Michael E. Reg. No. 36,801); Robert W. Zelnick (Reg. No. 136).
Please address all corresp	oondence and telephon	e calls to:
Ma 60 W	ck Q. Lever, Jr. CDERMOTT, WILL & O Thirteenth Street, N. ashington, D.C. 20005 02) 756-8000	W.
instructions from <u>Maee</u> Trademark Office regard attorney and the undersig	la Patent Office ing this application w ned. In the event of a	attorneys named herein to accept and follow as to any action to be taken in the Patent and ithout direct communication between the U.S. change in the persons from whom instructions will be so notified by the undersigned.
all statements made on i statements were made wi punishableby fine or impo	nformation and belief th the knowledge that visionment, or both, und	herein of my own knowledge are true and that are believed to be true; and further that these villful false statements and the like so made are ler Section 1001 of Title 18 of the United States jeopardize the validity of the application or any
Full name of sole or first	inventor	Osamu MATSUI
Inventor's signature	Osamu Mats	Date October 20, 2003
Residence* Kyoto, Japa		Citizenship <u>Japan</u>
Post Office Address 638-	l 101, Kamitenjin-cho, I	Kamigyo-ku, Kyoto-shi, Kyoto 602-0000, Japan

Full name of second inventor	Yoshinobu SATO		
Inventor's signature Yoshinoba Sa	## Date Gotober 20, 2003		
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^{*} City and State, or City and Country for foreign inventors

SEMICONDUCTOR DEVICE AND METHOD FOR FABRICATING THE SAME

BACKGROUND OF THE INVENTION

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The present invention relates to a semiconductor device and a method for fabricating the device, and more particularly relates to a semiconductor device in which MOS transistors are formed on an SOI (silicon on insulator) substrate, and a method for fabricating the device.

Conventionally, semiconductor devices that have a MOS structure, in which a Pchtransistor and an Nch-transistor are formed on an SOI substrate, have found a wide variety of applications. Particularly, the patent document 1 (Japanese Laid-Open Patent Publication No. 3111947 (FIG. 1 and descriptions thereof)) discloses a semiconductor device for use in a driving circuit in a plasma display, which semiconductor device employs MOS transistors with an offset structure in order to obtain a high breakdown-voltage characteristic.

FIG. 6 is a cross-sectional view of a conventional semiconductor device that includes transistors with an offset structure as the semiconductor device disclosed in the patent document 1 does. In the semiconductor device shown in FIG. 6, an N-channel transistor and a P-channel transistor, each being a MOS transistor with an offset structure, are formed on a common SOI substrate.

As shown in FIG. 6, the conventional semiconductor device includes a buried oxide film 102, a semiconductor layer 103, trench isolation regions 104, field oxide films 105a through 105d, and an interlevel dielectric film 106. The buried oxide film 102 is formed on a supporting substrate (silicon substrate) 101. The semiconductor layer 103 is formed on the buried oxide film 102. The trench isolation regions 104 are provided to divide the semiconductor layer 103 into a plurality of active regions 103a, 103b, The field oxide